



HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- n HIGH VOLTAGE CAPABILITY
- n LOW SPREAD OF DYNAMIC PARAMETERS
- n MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- NOTE OF THE PROPERTY OF THE

APPLICATIONS

n COMPACT FLUORESCENT LAMPS (CFLS)

DESCRIPTION

The device is manufactured using High Voltage Multi Epitaxial Planar technology for high switching speeds and high voltage capability. It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

The STBV series is designed for use in Compact Fluorescent Lamps.

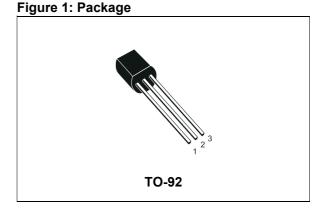


Figure 2: Internal Schematic Diagram

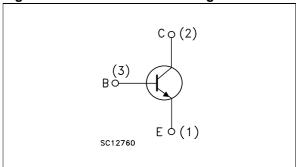


Table 1: Order Codes

Part Number	Marking	Package	Packaging
STBV32	BV32	TO-92	Bulk
STBV32-AP	BV32	TO-92	Ammopack

Table 2: Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-Emitter Voltage (V _{BE} = 0)	700	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	400	V
V _{EBO}	Emitter-Base Voltage ($I_C = 0$, $I_B = 0.5 A$, $t_p < 10 ms$)	V _{(BR)EBO}	V
	Collector Current	1.5	А
I _C	(f \geq 100 Hz, duty-cycle \leq 50 %, T _C = 25 °C)		
I _{CM}	Collector Peak Current (t _p < 5ms)	3	А
I _B	Base Current	0.5	А
I _{BM}	Base Peak Current (t _p < 5ms)	1.5	А
P _{tot}	Total Dissipation at T _C = 25 °C	1.5	W

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Symbol	Parameter	Value	Unit
T _{stg}	Storage Temperature	-65 to 150	°C
T _J	Max. Operating Junction Temperature	150	°C

Table 3: Thermal Data

R _{thj-case}	Thermal Resistance Junction-case	Max	83.3	°C/W
R _{thj-amb}	Thermal Resistance Junction-Ambient	Max	112	°C/W

Table 4: Electrical Characteristics ($T_{case} = 25$ °C unless otherwise specified)

Symbol	Parameter	Test Co	nditions	Min.	Тур.	Max.	Unit
I _{CEV}	Collector Cut-off Current	V _{CE} = 700 V				1	mA
	(V _{BE} = -1.5 V)	V _{CE} = 700 V	T _j =125 °C			5	mA
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	I _E = 10 mA		9		18	V
	$(I_C = 0)$						
V _{CEO(sus)} *	Collector-Emitter Sustaining Voltage	I _C = 10 mA		400			V
	$(I_B = 0)$						
V _{CE(sat)} *	Collector-Emitter	I _C = 0.5 A	I _B = 100 mA			0.5	V
	Saturation Voltage	I _C = 1 A	$I_{B} = 250 \text{ mA}$			1	V
		I _C = 1.5 A	I _B = 500 mA			1.5	V
V _{BE(sat)} *	Base-Emitter Saturation	I _C = 0.5 A	I _B = 100 mA			1.0	V
	Voltage	I _C = 1 A	$I_{B} = 250 \text{ mA}$			1.2	V
h _{FE}	DC Current Gain	I _C = 0.5 A	V _{CE} = 2 V	8		35	
		I _C = 1 A	$V_{CE} = 2 V$	5		25	
	RESISTIVE LOAD	I _C = 1 A	V _{CC} = 125 V				
t _r	Rise Time	$I_{B1} = -I_{B2} = 200 \text{ mA}$	t _p = 25 μs			1	μs
t_s	Storage Time	(see figure 12)				4	μs
t _f	Fall Time					0.7	μs
	INDUCTIVE LOAD	I _C = 1 A	V _{clamp} = 300 V				
t_s	Storage Time	I _{B1} = 200 mA	$V_{BE(off)} = -5V$		8.0		μs
		L = 50 mH	$R_{BB} = 0$				
		(see figure 13)					

^{*} Pulsed: Pulsed duration = 300 μs, duty cycle ≤ 1.5 %.

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Figure 3: Safe Operating Area

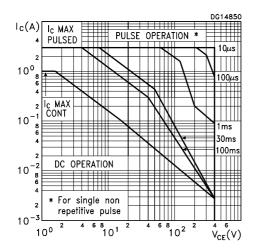


Figure 4: Output Characteristics

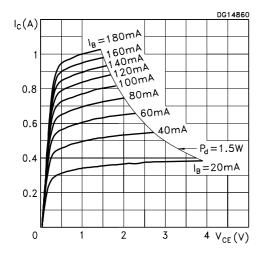


Figure 5: Base-Emitter Saturation Voltage

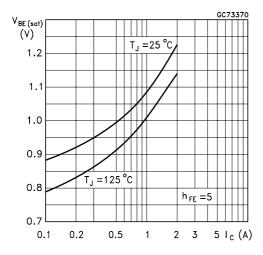


Figure 6: Derating Curve

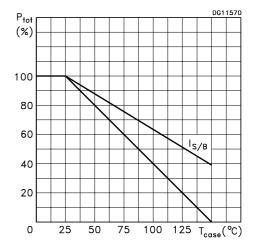


Figure 7: Collector-Emitter Saturation Voltage

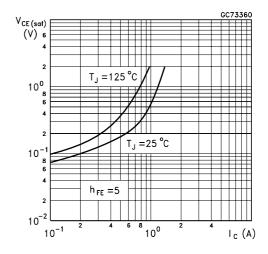


Figure 8: DC Current Gain

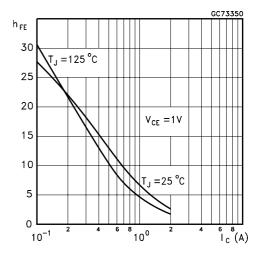


Figure 9: DC Current Gain

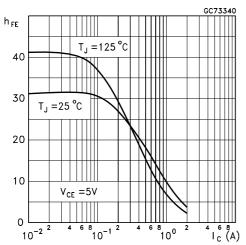


Figure 10: Reverse Biased Operating Area

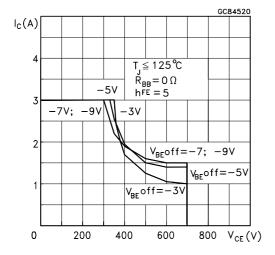
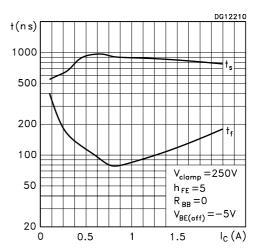


Figure 11: Inductive Load Switching Times



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Figure 12: Resistive Load Switching Test Circuit

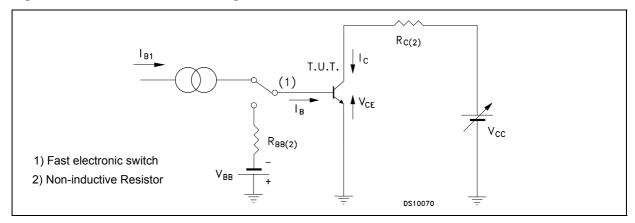
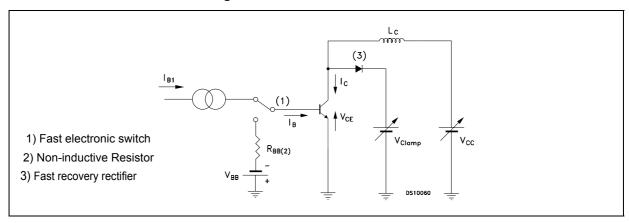
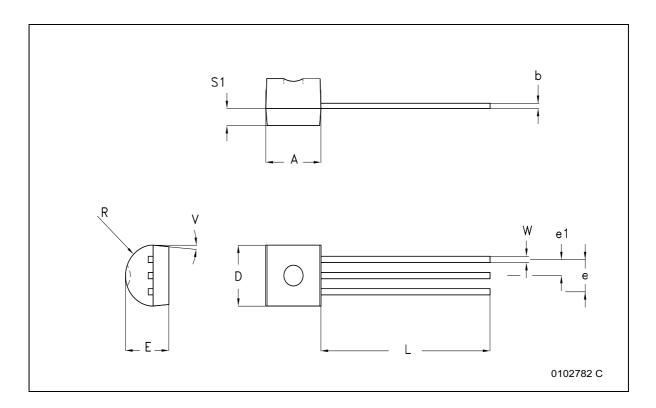


Table 13: Inductive Load Switching Test Circuit



TO-92 BULK SHIPMENT MECHANICAL DATA

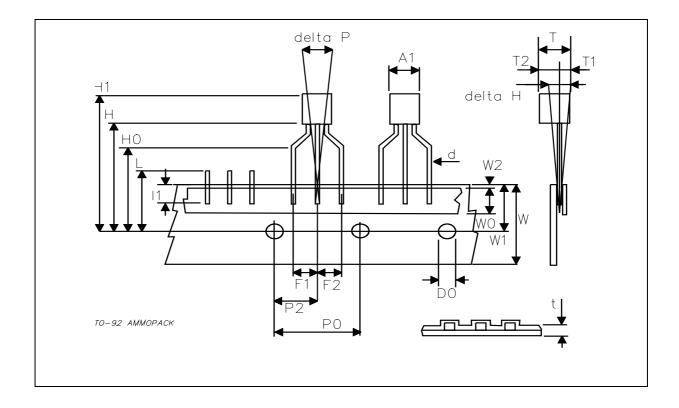
DIM.	mm.					
DIWI.	MIN.	ТҮР	MAX.			
А	4.32		4.95			
b	0.36		0.51			
D	4.45		4.95			
E	3.30		3.94			
е	2.41		2.67			
e1	1.14		1.40			
L	12.70		15.49			
R	2.16		2.41			
S1	0.92		1.52			
W	0.41		0.56			
V		5 ^O				



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TO-92 AMMOPACK SHIPMENT (Suffix"-AP") MECHANICAL DATA

DIM.	mm.				
	MIN.	TYP	MAX.		
A1			4.80		
Т			3.80		
T1			1.60		
T2			2.30		
d			0.48		
P0	12.50	12.70	12.90		
P2	5.65	6.35	7.05		
F1,F2	2.44	2.54	2.94		
delta H	-2.00		2.00		
W	17.50	18.00	19.00		
W0	5.70	6.00	6.30		
W1	8.50	9.00	9.25		
W2			0.50		
Н	18.50		20.50		
H0	15.50	16.00	16.50		
H1			25.00		
D0	3.80	4.00	4.20		
t			0.90		
L			11.00		
I1	3.00				
delta P	-1.00		1.00		



STBV32

Figure 1: Revision History

Version	Release Date	Change Designator
01-Dec-2002	1	First Release.
27-Apr-2005	1	Total dissipation value has been modified.

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